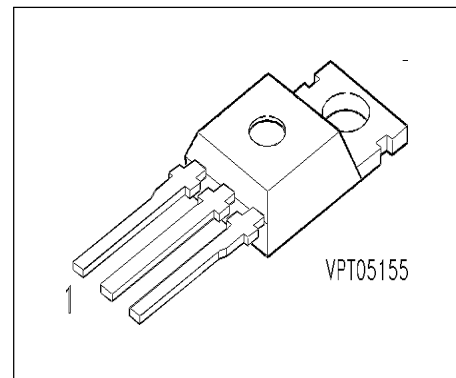


### SIPMOS<sup>®</sup> Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated



Pin 1	Pin 2	Pin 3
G	D	S

Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package	Ordering Code
BUZ 20	100 V	13.5 A	0.2 $\Omega$	TO-220 AB	C67078-S1302-A2

### Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current $T_C = 28\text{ }^{\circ}\text{C}$	$I_D$	13.5	A
Pulsed drain current $T_C = 25\text{ }^{\circ}\text{C}$	$I_{Dpuls}$	54	
Avalanche current, limited by $T_{jmax}$	$I_{AR}$	13.5	
Avalanche energy, periodic limited by $T_{jmax}$	$E_{AR}$	7.9	mJ
Avalanche energy, single pulse $I_D = 13.5\text{ A}$ , $V_{DD} = 25\text{ V}$ , $R_{GS} = 25\text{ }\Omega$ $L = 486\text{ }\mu\text{H}$ , $T_j = 25\text{ }^{\circ}\text{C}$	$E_{AS}$	59	
Gate source voltage	$V_{GS}$	$\pm 20$	V
Power dissipation $T_C = 25\text{ }^{\circ}\text{C}$	$P_{tot}$	75	W
Operating temperature	$T_j$	-55 ... + 150	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$	-55 ... + 150	
Thermal resistance, chip case	$R_{thJC}$	$\leq 1.67$	K/W
Thermal resistance, chip to ambient	$R_{thJA}$	75	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

## Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage $V_{GS} = 0\text{ V}$ , $I_D = 0.25\text{ mA}$ , $T_j = 25\text{ }^{\circ}\text{C}$	$V_{(BR)DSS}$	100	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}$ , $I_D = 1\text{ mA}$	$V_{GS(th)}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 100\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_j = 25\text{ }^{\circ}\text{C}$ $V_{DS} = 100\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_j = 125\text{ }^{\circ}\text{C}$	$I_{DSS}$	- -	0.1 10	1 100	$\mu\text{A}$
Gate-source leakage current $V_{GS} = 20\text{ V}$ , $V_{DS} = 0\text{ V}$	$I_{GSS}$	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 10\text{ V}$ , $I_D = 8.5\text{ A}$	$R_{DS(on)}$	-	0.17	0.2	$\Omega$

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Dynamic Characteristics**

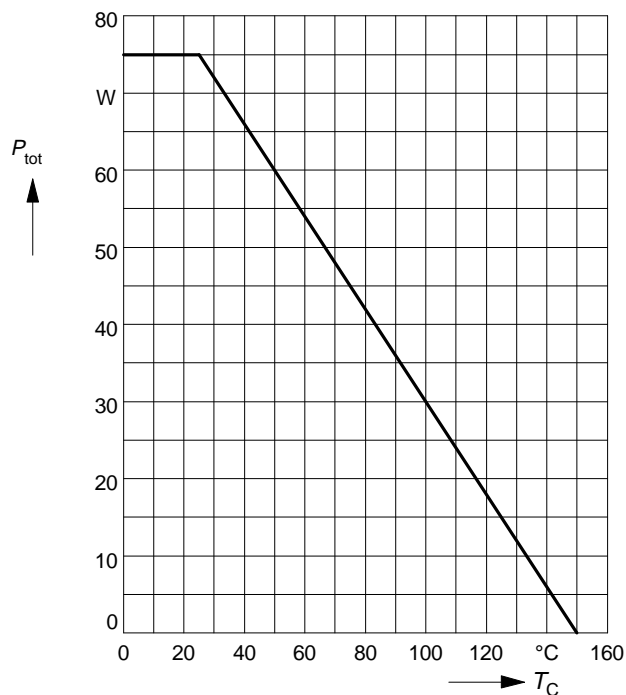
Transconductance $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$ , $I_D = 8.5\text{ A}$	$g_{fs}$	3	4.7	-	S
Input capacitance $V_{GS} = 0\text{ V}$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$	$C_{iss}$	-	400	530	pF
Output capacitance $V_{GS} = 0\text{ V}$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$	$C_{oss}$	-	120	180	
Reverse transfer capacitance $V_{GS} = 0\text{ V}$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$	$C_{rss}$	-	70	105	
Turn-on delay time $V_{DD} = 30\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$ $R_{GS} = 50\ \Omega$	$t_{d(on)}$	-	10	15	ns
Rise time $V_{DD} = 30\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$ $R_{GS} = 50\ \Omega$	$t_r$	-	45	70	
Turn-off delay time $V_{DD} = 30\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$ $R_{GS} = 50\ \Omega$	$t_{d(off)}$	-	55	75	
Fall time $V_{DD} = 30\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$ $R_{GS} = 50\ \Omega$	$t_f$	-	40	55	

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current $T_C = 25\text{ }^{\circ}\text{C}$	$I_S$	-	-	13.5	A
Inverse diode direct current,pulsed $T_C = 25\text{ }^{\circ}\text{C}$	$I_{SM}$	-	-	54	
Inverse diode forward voltage $V_{GS} = 0\text{ V}$ , $I_F = 27\text{ A}$	$V_{SD}$	-	1.4	1.6	V
Reverse recovery time $V_R = 30\text{ V}$ , $I_F=I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$	$t_{rr}$	-	170	-	ns
Reverse recovery charge $V_R = 30\text{ V}$ , $I_F=I_S$ , $di_F/dt = 100\text{ A}/\mu\text{s}$	$Q_{rr}$	-	0.3	-	$\mu\text{C}$

## Power dissipation

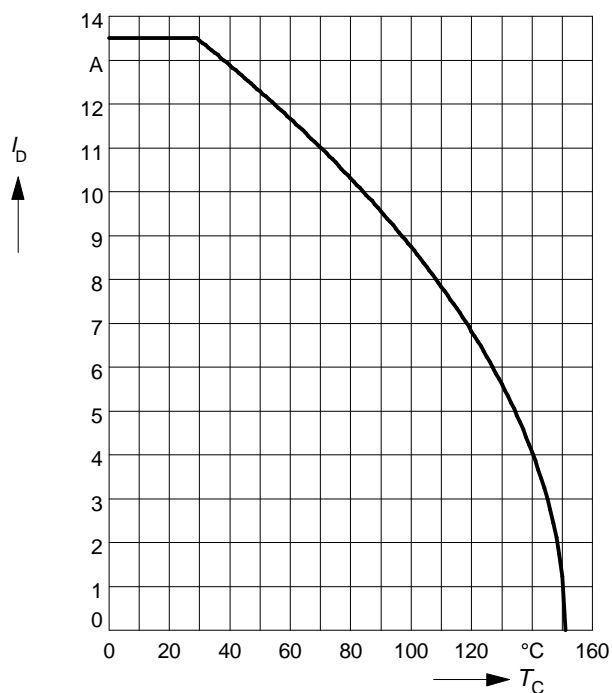
$$P_{\text{tot}} = f(T_C)$$



## Drain current

$$I_D = f(T_C)$$

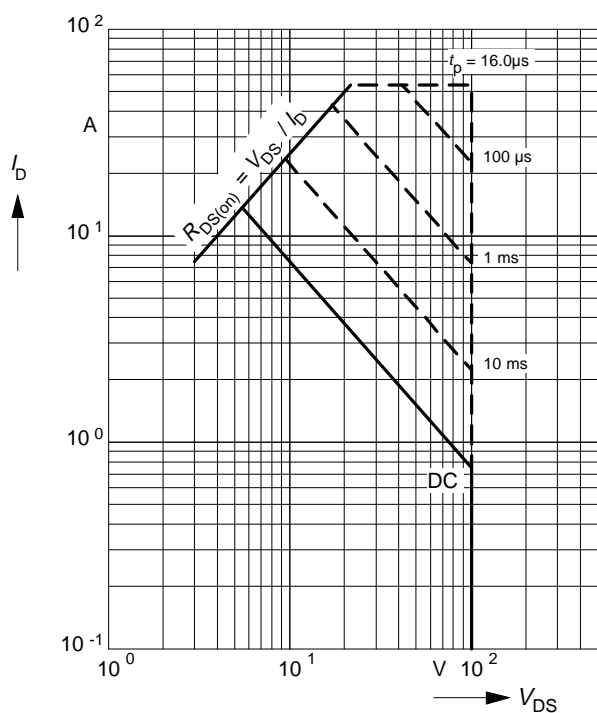
parameter:  $V_{\text{GS}} \geq 10 \text{ V}$



## Safe operating area

$$I_D = f(V_{\text{DS}})$$

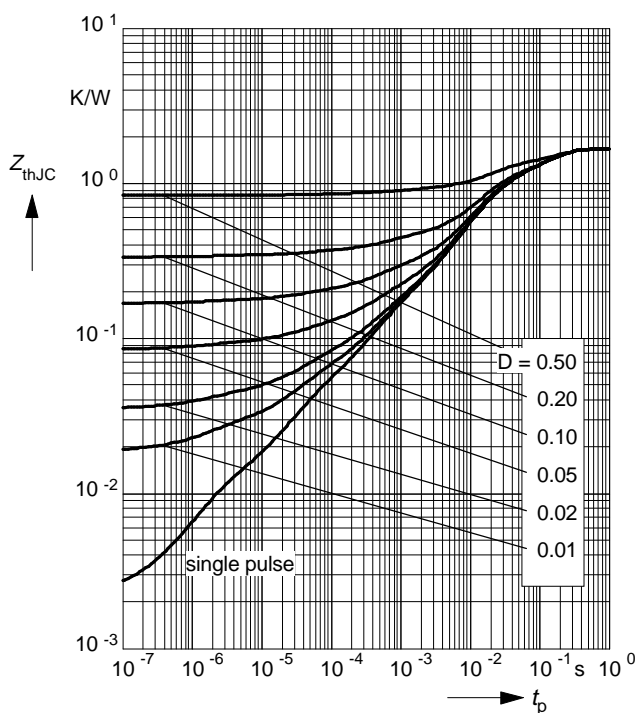
parameter:  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$



## Transient thermal impedance

$$Z_{\text{th JC}} = f(t_p)$$

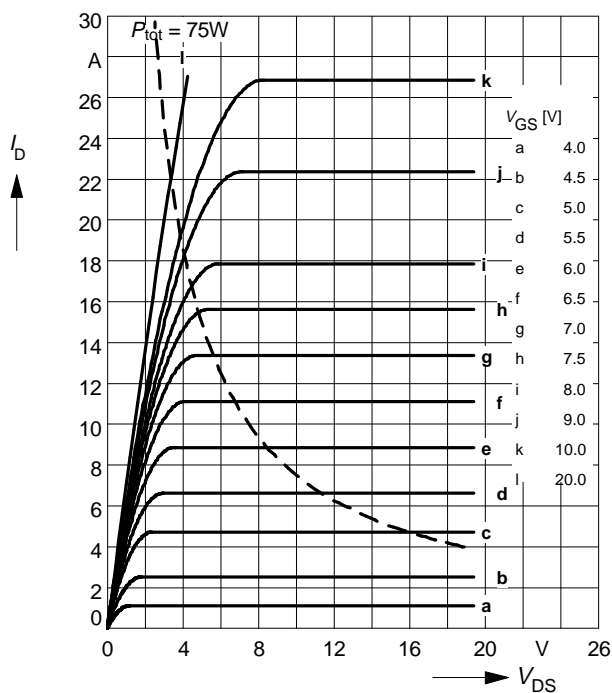
parameter:  $D = t_p / T$



## Typ. output characteristics

$$I_D = f(V_{DS})$$

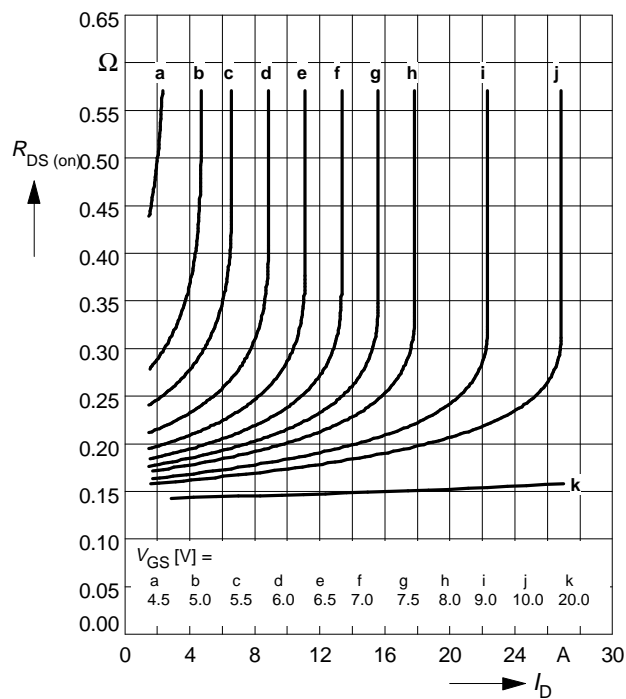
parameter:  $t_p = 80 \mu s$



## Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

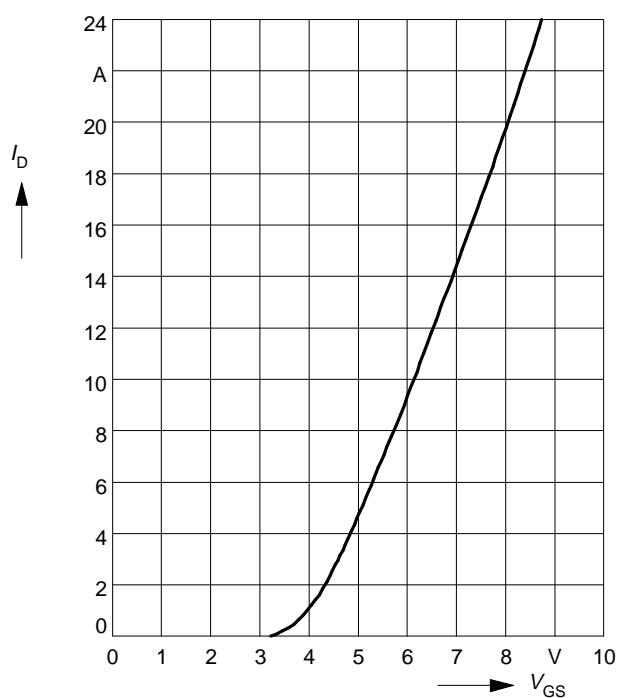
parameter:  $V_{GS}$



## Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$

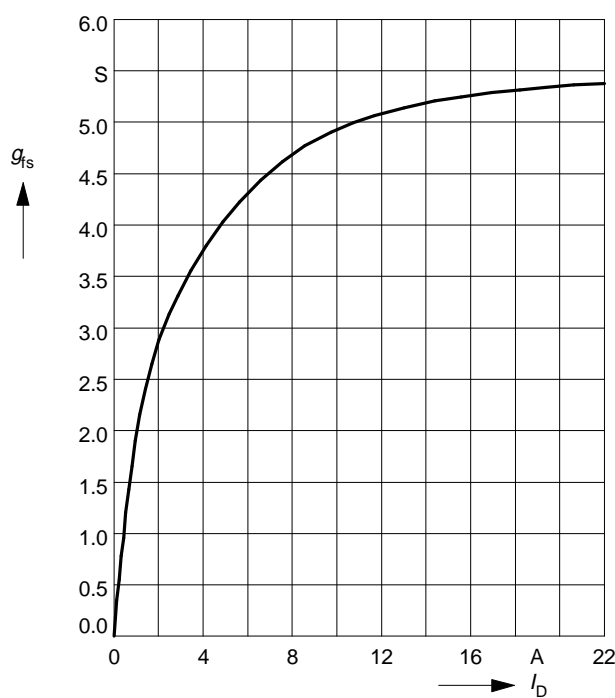
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



## Typ. forward transconductance $g_{fs} = f(I_D)$

parameter:  $t_p = 80 \mu s$ ,

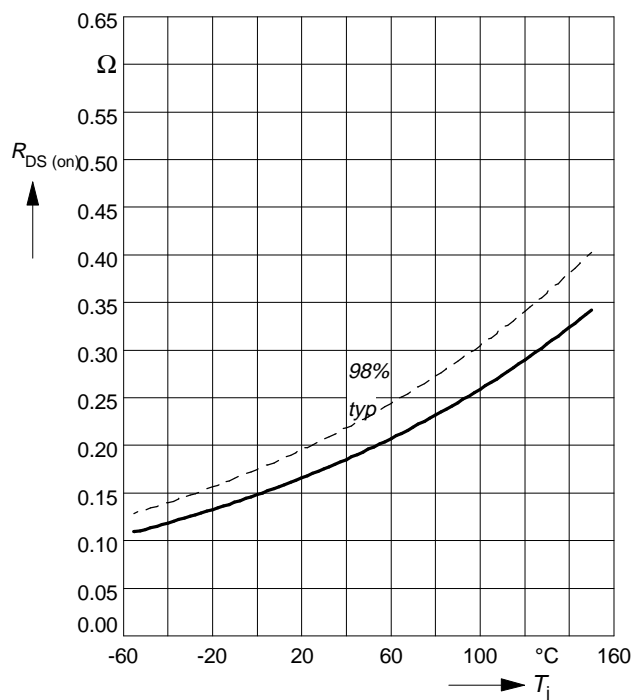
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



## Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

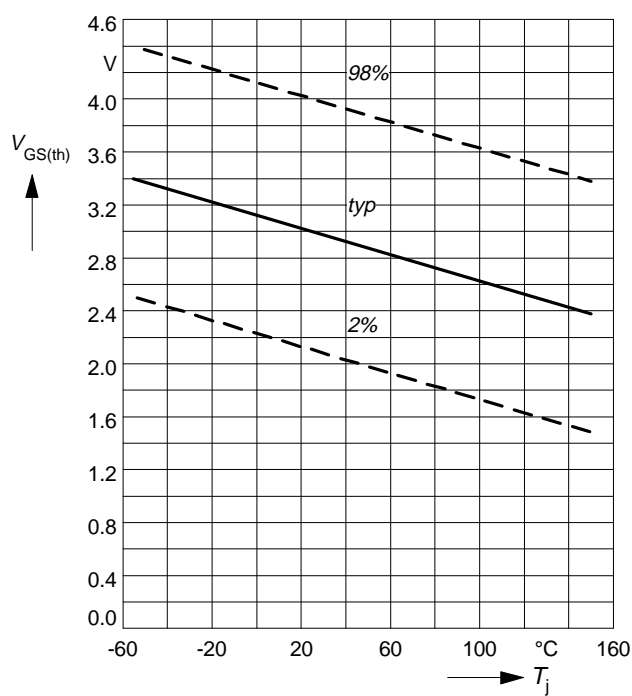
parameter:  $I_D = 8.5 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$



## Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

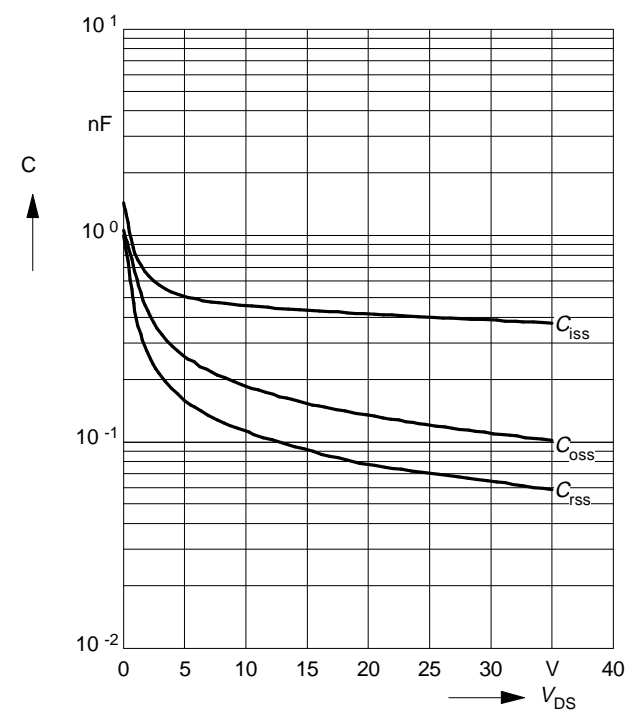
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 1 \text{ mA}$



## Typ. capacitances

$$C = f(V_{DS})$$

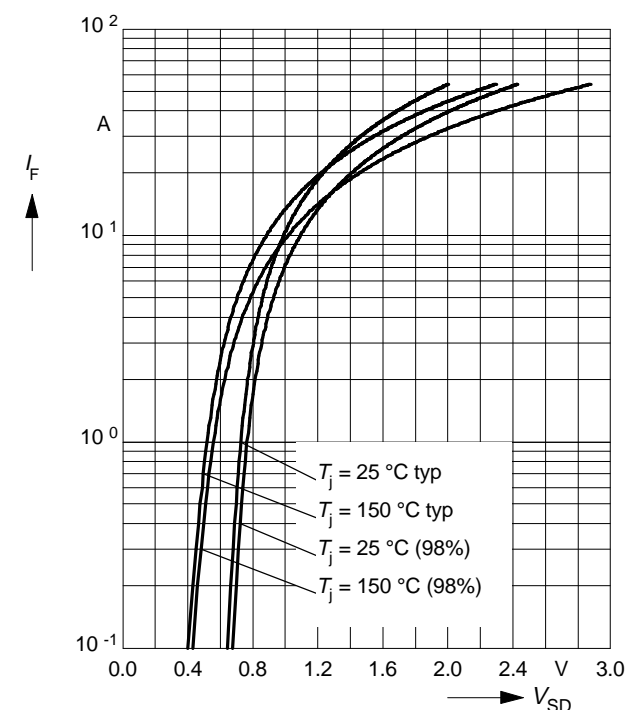
parameter:  $V_{GS} = 0 \text{ V}$ ,  $f = 1 \text{ MHz}$



## Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

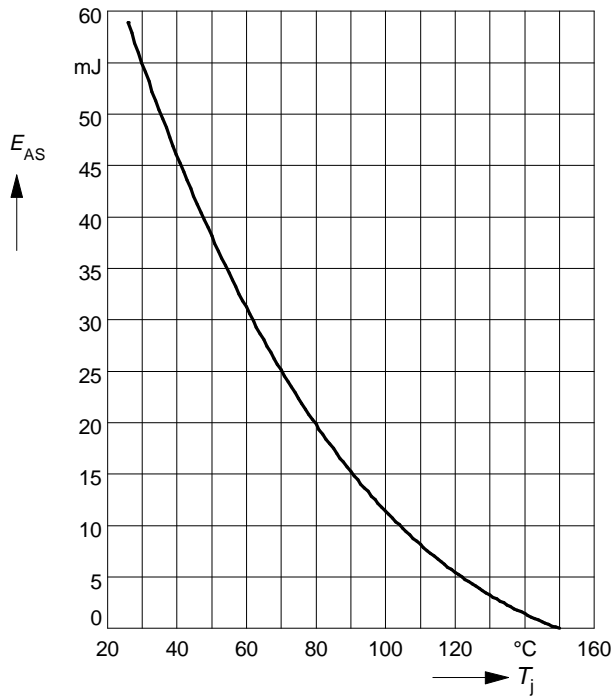
parameter:  $T_j$ ,  $t_p = 80 \mu\text{s}$



## Avalanche energy $E_{AS} = f(T_j)$

parameter:  $I_D = 13.5 \text{ A}$ ,  $V_{DD} = 25 \text{ V}$

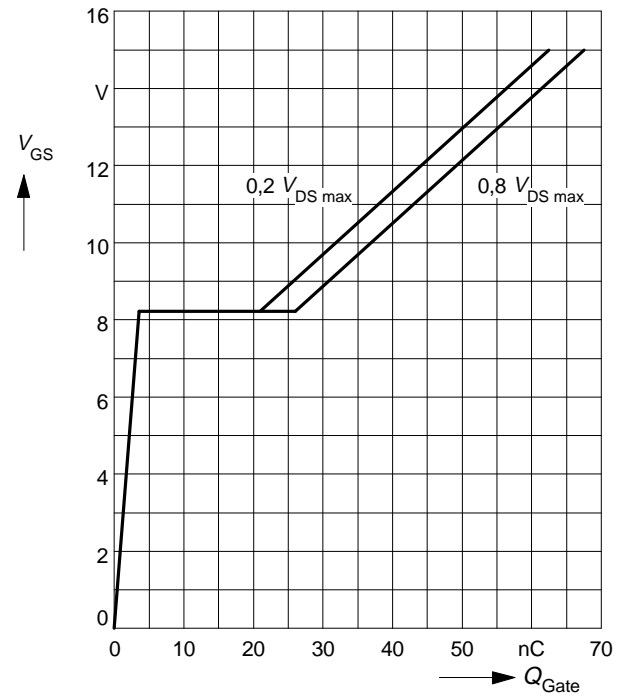
$R_{GS} = 25 \Omega$ ,  $L = 486 \mu\text{H}$



## Typ. gate charge

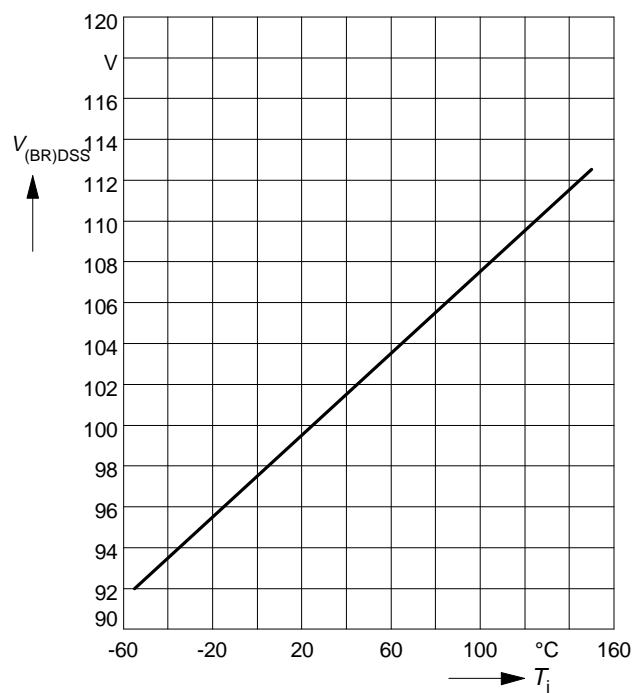
$V_{GS} = f(Q_{\text{Gate}})$

parameter:  $I_{D \text{ puls}} = 15 \text{ A}$



## Drain-source breakdown voltage

$V_{(BR)DSS} = f(T_j)$





## Package Outlines

TO-220 AB

Dimension in mm

